

Reconfigurable Electrical Probing System for Thin Film Devices

Verification & Validation Document

ELEC 491 Capstone Project University of British Columbia

April 8, 2025

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1. Project Overview

Our team, JY85, is developing a reconfigurable probing system called OrcaProbe to probe thin film devices as requested by our client, Orca Advanced Materials Inc. This project will create a consolidated testing system capable of carrying out 2, 3, and 4-probe measurements while communicating and being powered by a host PC via USB connection.

2. Document Overview

This document outlines the strategies, tests, and criteria used to confirm our system meets its design specifications and performs in real-world scenarios. The purpose of this document is to list and organize the tests we will be conducting throughout the project to verify and validate our designs. Verification tests focus on ensuring the system's functionality and performance, while validation tests confirm that our integrated system meets our client's needs and use cases. Each test has an overview of the purpose of the test, the procedure required to perform the test, expected outcomes as a result of theory or simulations, and the results of carrying out the test. Each test fulfills requirements, ensuring that our project is on the right track.

3. Product Verification

Verification tests assess whether the system has been built correctly according to its design specifications and requirements. These tests ensure that each component and subsystem performs as intended.

3.1 Verification Plan Description

This section explains the OrcaProbe Verification test plans. Each verification test is outlined below in Section 3.2 using test cards. Each test card confines all the related details about a verification test within its scope. The parts of the test cards are as follows.

- Tests are given an identity label that starts with the prefix VER, followed by
 2-letter identifiers for the test field/scope and ends with the test number.
- Each test has a short title.
- **Test Overview** explains the scope and aim of the verification test.
- Parent Specification provides a reference to the specification the test aims to check and see whether it is met or not.
- Test Procedure explains the steps to execute the test.
- **Expected Outcome** lists the behaviour to observe to decide whether the tests pass or not. Any deviation from the expected outcome is considered a "Fail" unless a reason is given. In this case, the expected outcome can be updated.
- Date Executed and Executed By provide bookkeeping-related information on who
 executed the test and when they executed it.
- Test Case Results highlight the latest state of the verification tests. Additional details can also be provided when necessary.

Verification Tests are divided into functional categories that concern individual parts or the integration of multiple parts. These categories, their scopes and the number of tests under them are as follows:

- Basic PCB Functionality: Aims to verify basic and miscellaneous PCB functionalities. These test plans ensure the PCB can be powered up and accessed via USB.
- Probe Sourcing: Aims to verify that the probes can be used as inputs by sourcing voltage and current. These test plans ensure PCB can supply the necessary electrical signals to carry out measurements.
- Probe Monitoring: Aims to verify that the probes can be used as outputs by measuring voltage and current. These test plans ensure the PCB can sample the necessary electrical signals to carry out measurements.
- Probe Toggling: Aims to verify that the probes can be reconfigured to functionally act as input or outputs when necessary. These test plans ensure PCB offers reconfigurability of probe functionalities.
- Embedded Firmware Program: Aims to verify the MCU and the firmware program. These test plans ensure that the hardware system overall behaves as intended and executes the measurements.
- Software GUI: Aims to verify the software controller GUI, both the backend and
 the frontend. These test plans ensure that the GUI can control all the necessary
 components of the hardware and provide a seamless process to the user.
- Device-to-Host Communication: Aims to verify the device-to-host communication. These test plans ensure that the GUI and MCU can communicate. All the information exchange happens over this channel. All message structures are tested to verify that their behaviour is as expected.
- Mechanical Chassis: Aims to verify that the chassis is durable, securely holds the PCB in place without movement, and provides sufficient room for the probes to extend.
- End-to-End Measurement: Aims to verify the complete system datapath from GUI to hardware. There are dedicated tests for each measurement method.
 These test plans are directly correlated to the main device functionalities.

3.2 Test Plans

3.2.1 Basic PCB Functionality

VER.HW.1 - PCB Bring Up			
Test Overview	This test verifies that the PCB of the hardware system can be brought up.		
Parent Specification	FR-2		
Test Procedure	 Connect the PCB to the host computer using a USB cable. Check voltages on power rails using a multimeter. 		
Expected Outcome	 All voltage rails should be at their dedicated values. (e.g. 5V, 3.3V, 1.8V, etc.) 		
Date Executed	2025-03-30		
Executed by	DS		
Test Case Results	Pass	Fail	Incomplete

VER.HW.2 - PCB Power Status LED				
Test Overview	This test verifies that the PCB can drive the power status LED correctly.			
Parent Specification	FR-4.2			
Test Procedure	cable.	2. Observe the power status LED over multiple power		
Expected Outcome	 The LED should turn ON whenever the USB power is connected. 			
Date Executed	2025-03-30			
Executed by	DS			
Test Case Results	Pass	Pass Fail Incomplete		

VER.HW.3 - USB Link Status LED				
Test Overview		This test verifies that the PCB can drive the USB link connection status LED correctly.		
Parent Specification	FR-4.2			
Test Procedure	cable. 2. Run the GUI p 3. Observe the	 Connect the PCB to the host computer using a USB cable. Run the GUI program to open the serial port connection. Observe the USB link connection status LED over multiple power cycles. 		
Expected Outcome	The LED should turn ON whenever the USB link is connected.			
Date Executed	2025-03-30			
Executed by	DS - KO			
Test Case Results	Pass	Fail	Incomplete	

3.2.2 Probe Sourcing

3.2.2.1 Voltage Source Tests

VER.PS.1 - No-Load Voltage Test				
Test Overview		This test verifies that the output voltage wave matches the input setting under no-load conditions.		
Parent Specification	FR-1.1.1			
Test Procedure	 Make sure the samples (loa Connect the specific frequency 	 Extend 2 probes. Make sure the probes are not in contact with any test samples (load). Connect the USB power cable to the PCB. Configure the AD9833 to generate a sine wave at a specific frequency and amplitude. Measure the waveform directly at the probes with an oscilloscope 		
Expected Outcome	The measured amplitude, frequency, and waveform should match the input setting within acceptable tolerances.			
Date Executed	2025-03-30			
Executed by	DS - KO			
Test Case Results	Pass	Fail	Incomplete	

VER.PS.2 - Load Regulation				
Test Overview		This test verifies that the voltage amplitude of the waveform remains consistent under different test samples.		
Parent Specification	FR-1.1.1			
Test Procedure	 Configure the Connect the Configure the specific frequency Probe one of lab equipments sample. 	 Configure the probe position. Connect the USB power cable to the PCB. Configure the AD9833 to generate a sine wave at a specific frequency and amplitude. Probe one of the test samples and measure, with the lab equipment, the voltage being supplied to the 		
Expected Outcome	The waveform generator should source the same voltage amplitude across all the test samples.			
Date Executed	2025-03-30			
Executed by	DS - KO			
Test Case Results	Pass	Fail	Incomplete	

VER.PS.3 - DC Source	VER.PS.3 - DC Source (0.1Hz)			
Test Overview	This test verifies that the waveform generator outputs a DC source when the frequency is set to 0.1 Hz.			
Parent Specification	FR-1.1.1			
Test Procedure	 Extend 2 probes. Make sure the probes are not in contact with any test samples. Connect the USB power to the PCB. Configure the AD9833 to generate an output at 0.1 Hz and various voltage amplitudes: 0.5V, 1V, 2.5V. 5V. Measure the output voltage across the probes with the lab equipment. Repeat steps 4-5 with different voltage amplitudes. 			

Expected Outcome	The output waveform should be a flat line at the voltage set by the microcontroller, with no curves representing a DC output.		
Date Executed	2025-03-30		
Executed by	DS - KO		
Test Case Results	Pass	Fail	Incomplete

VER.PS.4 - High-Frequency Stability (12.5MHz)						
Test Overview	This test verifies tha frequencies.	t the waveform is stal	ole at high			
Parent Specification	FR-2.1.2					
Test Procedure	 Extend 2 probes. Make sure the probes are not in contact with any test samples. Connect the USB power to the PCB. Configure the AD9833 to generate a sine wave at its maximum frequency output of 12.5 MHz and various voltage amplitudes: 0.5V, 1V, 2.5V, and 5V. Measure the output voltage across the probes with the lab equipment. Repeat steps 4-5 with different voltage settings. 					
Expected Outcome	 The output waveform should be stable with no stepping effect on the sine wave. 					
Date Executed	2025-03-30					
Executed by	DS - KO	DS - KO				
Test Case Results	Pass	Pass Fail Incomplete				
	As agreed by the client, FR-2.1.2 was changed to have a maximum operating frequency of 1MHz instead of 10MHz. This was to trade off accuracy performance against sampling speed. A high-frequency supply was still tested to ensure the hardware system is able to support it if needed in the future.					

3.2.2.2 Current Source Tests

VER.PS.5 - No-Load	VER.PS.5 - No-Load Test			
Test Overview	calcul	This test verifies that the current source's output equals the calculated output current configured by the digital potentiometers without any load.		
Parent Specification	FR-1.1	.1		
Test Procedure	2. 3. 4.	 Extend 2 probes. Make sure the probes are not in contact with any test samples. Connect the USB power to the PCB. Sweep the digital potentiometer resistance from ~70Ω to 100kΩ. Measure the output current at the probes using a multimeter. 		
Expected Outcome	• Output current should range from $\sim 50 \mu A (100 k\Omega)$ to $\sim 15 mA (70 \Omega)$.			
Date Executed	2025-03-30			
Executed by	DS - KO			
Test Case Results	Pass		Fail	Incomplete

VER.PS.6 - Load Regu	VER.PS.6 - Load Regulation Test				
Test Overview	This test verifies the varying loads.	This test verifies that the output current remains stable under varying loads.			
Parent Specification	FR-1.1.1				
Test Procedure	 Configure the Connect the I Connect the I Set the digita Extend 2 prot Measure the multimeter. Sweep the po Compare the 	 Prepare a selection of different test samples. Configure the probe position. Connect the USB power cable to the PCB. Connect the USB cable. Set the digital potentiometer to ~70Ω Extend 2 probes to contact the test sample. Measure the current through the load using a multimeter. Sweep the potentiometer to 100kΩ. Compare the currents across different resistive loads. Repeat steps 5-9 with different samples. 			
Expected Outcome	 Output current across the samples should be the same as the no-load condition and should not vary with load unless saturated. 				
Date Executed	2025-03-30				
Executed by	DS - KO				
Test Case Results	Pass	Pass Fail Incomplete			

3.2.3 Probe Monitoring

VER.PM.1 - DC Voltage Measurement Test						
Test Overview			at the monitor t DC voltage v	• .	em can accui	rately
Parent Specification	FR-2.2					
Test Procedure	 Extend 2 test probes. Connect the DC power supply outputs to the probes. Connect the USB power to the device. Enable output. Capture and record the data from the monitoring system. Visualize the data using either the software GUI or an external software. 					
		Voltage Amplitudes (V) Frequency Values				
		0.5		0.5 Hz		
		1 1 Hz				
		2.5 1 kHz				
		5 10 MHz				
Expected Outcome	 For each voltage and frequency level, the output should be a series of data points at or near the set voltage level. 					
Date Executed	2025-03-30					
Executed by	DS - KO					
Test Case Results	Pass		Fail		Incomplete	

VER.PM.2 - Sine Wave Measurement Test						
Test Overview		This test verifies that the monitoring system can accurately measure a sine wave up to 10 MHz.				
Parent Specification	FR-2.2					
Test Procedure	 Extend 2 test probes. Connect the function generator outputs to the probes. Connect USB power to the device. Set the lab function generator to a sine wave on a specified voltage level and frequency. Enable output. Capture and record data from the monitoring system. Visualize the data using either the software GUI or an external software. 					
	Voltage Amplitudes (V) Frequency Values					
	0.5 0.5 Hz					
	1		1 Hz			
	2.5		1 kHz			
	5 10 MHz					
Expected Outcome	For each voltage and frequency pair, the output should be a series of data points that resemble the specified sine wave.					
Date Executed	2025-03-30					
Executed by	DS - KO					
Test Case Results	Pass	Fail		Incomp	lete	

VER.PM.3 - DC Curren	VER.PM.3 - DC Current Measurement Test					
Test Overview		This test verifies that the monitoring system can accurately measure a constant DC current level.				
Parent Specification	FR-2.2					
Test Procedure	 Extend 2 test probes. Connect the positive side of the function generator output to the 1kΩ resistor. Connect an 11kΩ resistor to one test probe. Connect the negative side of the function generator output to the second test probe. Connect the USB power to the device. Configure the DC power supply to output at the specified voltage level. Enable output. Capture and record data from the monitoring system. 					
	Voltage Amplitudes (V) Expected Current (mA)					
		1		1		
		2.5		2.5		
		5		5		
	10 10					
Expected Outcome	For each voltage level, the output should be a series of data points at or near the expected current level.					
Date Executed	2025-04-01					
Executed by	DS - KO	DS - KO				
Test Case Results	Pass		Fail		Incomplete	

VER.PM.4 - Current Sine Wave Measurement Test						
Test Overview	1	This test verifies that the monitoring system can accurately measure a current sine wave up to 10 MHz.				
Parent Specification	FR-2.2					
Test Procedure	2. 3. 4. 5. 6.	 Extend 2 test probes. Connect the positive side of the function generator output to the 1kΩ resistor. Connect an 11kΩ resistor to one test probe. Connect the negative side of the function generator output to the second test probe. Connect USB power to the device. Set the lab function generator to output voltage sine wave at the specified voltage level and frequency. Enable output. Capture and record data from the monitoring system. 				
		Voltage Expected Frequency Amplitudes (V) Current (mA) Values				
		1 1 0.5 Hz				
		2.5		2.5	1 Hz	
		5		5	1 kHz	
	10 10 10 MHz					
Expected Outcome	For each voltage and frequency pair, the output should be a series of data points that resemble the specified sine wave.					
Date Executed	2025-04-01					
Executed by	DS - KO	DS - KO				
Test Case Results	Pass		Fail		Incomplete	

3.2.4 Probe Toggling

VER.PT.1 - Single Pin	VER.PT.1 - Single Pin Toggle Between Different Inputs				
Test Overview	This test verifies that the signal toggling mechanism works for a single pin.				
Parent Specification	FR-2.3				
Test Procedure	voltage and c 2. Apply DC volt second, curre 3. Use a load re probe.	crocontroller program current. cage on the first pin, AC ent on the third, and GN sistor to measure curre voltage/current for eac	C voltage on the ID on the fourth. ent on the third		
Expected Outcome	The resulting voltage and current at the output should be the supplied signal at the input, depending on which switch is toggled.				
Date Executed	2025-03-30				
Executed by	DS - KO				
Test Case Results	Pass	Fail	Incomplete		

3.2.5 Embedded Firmware Program

3.2.5.1 General Functionality

VER.FW.1 - Boot State	VER.FW.1 - Boot State Reset				
Test Overview	This test ensures the proper booting and shutdown of the MCU, verifying that the firmware resets to its initial state with the default values upon power-up.				
Parent Specification	FR-2.6.1				
Test Procedure	 Connect to the PCB using USB and ST-Link stick. Check default values for firmware variables using the STM32CubeIDE debugger. Using the GUI, send configuration data. Ensure variables are updated as intended. Disconnect and reconnect the USB to power-cycle the PCB and MCU. Check default values for firmware variables using the STM32CubeIDE debugger. 				
Expected Outcome	Variables seen in steps 2 and 6 should match.				
Date Executed	2025-03-30				
Executed by	КО				
Test Case Results	Pass	Fail	Incomplete		

VER.FW.2 - User Asse	VER.FW.2 - User Asserted Reset				
Test Overview	This test ensures the proper resetting of the MCU, verifying that the firmware resets to its initial state with the default values upon a user-asserted reset.				
Parent Specification	FR-2.6.2				
Test Procedure	 Connect to the PCB using USB and ST-Link stick. Check default values for firmware variables using the STM32CubeIDE debugger. Using the GUI, send configuration data. Ensure variables are updated as intended. Assert the hardware reset by pressing the mechanical reset button. 				

	 Check default values for firmware variables using the STM32CubeIDE debugger. Using the GUI, send configuration data. Ensure variables are updated as intended. Assert software reset by pressing the reset button on the GUI. Check default values for firmware variables using the STM32CubeIDE debugger. 				
Expected Outcome	 Variables seen in step 2, step 6 and step 10 should match. 				
Date Executed	2025-03-30				
Executed by	КО				
Test Case Results	Pass	Fail	Incomplete		

VER.FW.3 - Switch Ne	VER.FW.3 - Switch Network Control				
Test Overview	This test verifies that the MCU can control all the individual relays of the switch network and connect all 4 probes to each functionality circuit.				
Parent Specification	FR-2.3				
Test Procedure	 Run a dedicat each GPIO pir Monitor value STM32Cubell Check for cor 	 Connect to the PCB using USB and ST-Link stick. Run a dedicated program in DEBUG mode that goes over each GPIO pin for each relay and toggles them. Monitor values for firmware variables using the STM32CubeIDE debugger. Check for connectivity between the probes and the functionality circuit using a multimeter. 			
Expected Outcome	Multimeter should pass continuity checks by showing a continuous path.				
Date Executed	2025-03-30				
Executed by	КО				
Test Case Results	Pass	Fail	Incomplete		

3.2.5.2 MCU to IC Communication

VER.FW.4 - Voltage Source Configuring via SPI					
Test Overview	This test verifies the SPI bus functionality between the MCU and voltage source IC, AD9833, ensuring desired data communication between the two ends.				
Parent Specification	FR-3.3.2, FR-2.1				
Test Procedure	 Connect the oscilloscope to the SPI bus test lines. Connect to the PCB using USB and ST-Link stick. Set up the firmware to pause at SPI routines. Using the GUI, send configuration data that involves sweeping. When the breakpoint hits for the SPI routine, trigger the oscilloscope. Continue SPI routine. Capture the waveform on the oscilloscope, including the serial clock, chip select and serial data lines. 				
Expected Outcome	The captured waveform on the oscilloscope should match the serial data pattern specified on the AD9833 datasheet.				
Date Executed	2025-03-30				
Executed by	КО				
Test Case Results	Pass	Fail	Incomplete		

VER.FW.5 - Current So	VER.FW.5 - Current Source Configuring via I2C				
Test Overview	This test verifies the I2C bus functionality between the MCU and potentiometers of the current mirror, ensuring desired data communication between the two ends.				
Parent Specification	FR-3.3.2, FR-2.1				
Test Procedure	 Connect the oscilloscope to the I2C bus test lines. Connect to the PCB using USB and ST-Link stick. Set up the firmware to pause at I2C routines. Using the GUI, send configuration data that involves sweeping. When the breakpoint hits for the I2C routine, trigger the 				

	oscilloscope. 6. Continue the I2C routine. 7. Capture the waveform on the oscilloscope, including the serial clock and serial data lines.				
Expected Outcome	The captured waveform on the oscilloscope should match the serial data pattern specified on the MCP453X datasheet.				
Date Executed	2025-03-30				
Executed by	КО				
Test Case Results	Pass	Pass Fail Incomplete			

VER.FW.6 - ADC Clock	VER.FW.6 - ADC Clock Quality				
Test Overview	This test verifies that the clock signal generated by the MCU is fed to the ADCs (AD9235) in the required quality for sampling to function.				
Parent Specification	FR-2.2				
Test Procedure	 Connect to th Set up the firm Using the GUI static samplin When the bread oscilloscope. Continue the 	akpoint hits for the DM	ST-Link stick. A triggering routines. ata that involves IA routine, trigger the		
Expected Outcome	 The captured waveform on the oscilloscope should show minimal ringing, overshoot and jitter on the clock signal. It needs to have a 50% duty cycle. 				
Date Executed	2025-03-30				
Executed by	КО				
Test Case Results	Pass	Fail	Incomplete		

3.2.6 Software GUI

3.2.6.1 Front-End

VER.SW.1 - Boot State	VER.SW.1 - Boot State Reset			
Test Overview	This test ensures the proper booting and shutdown of the GUI, verifying that the software resets to its initial state with the default values.			
Parent Specification	FR-3.7			
Test Procedure	 Start the GUI Change the p measuremen measuremen Terminate the 	 Connect the device to the operator's pc. Start the GUI by running the Python file. Change the probe functionalities, toggle the measurement menu and enter input values for the measurements. Terminate the GUI. Start the GUI and observe the changes made. 		
Expected Outcome	 All the changes made should go back to their initial, default state. 			
Date Executed	2025-02-02			
Executed by	IB			
Test Case Results	Pass Fail Incomplete			

VER.SW.2 - Measuren	VER.SW.2 - Measurement Type Menu Toggling and Page Selection		
Test Overview	This test verifies that the measurement type selection menu on the left is toggleable, allowing only one measurement to be selected at a time, and ensures the corresponding page is displayed upon selection.		
Parent Specification	FR-3.2		
Test Procedure	 Connect the device to the operator's pc. Start the GUI by running the Python file. Toggle the measurement selection menu on the left to see what is displayed under each measurement category (2-probe, 3-probe, 4-probe). Select a measurement type and observe the corresponding page. 		

	5. Repeat steps 3-4 for all possible measurement types.		
Expected Outcome	 Selecting a measurement type should display its corresponding page in the main area. Previously selected measurement types should automatically be deselected when a new one is chosen. 		
Date Executed	2025-02-02		
Executed by	IB		
Test Case Results	Pass	Fail	Incomplete

VER.SW.3 - Providing	VER.SW.3 - Providing Measurement Input		
Test Overview	This test verifies that selecting a measurement type displays its corresponding input fields, allowing the device operator to enter values into the provided inputs.		
Parent Specification	FR-3.3		
Test Procedure	 Start the GUI I Choose a measure selection mer Observe the ir Enter values ir Monitor corres STM32CubelI 	 Connect the device to the operator's pc. Start the GUI by running the Python file. Choose a measurement type from the measurement selection menu on the left. Observe the input fields on the measurement page. Enter values in the input fields. Monitor corresponding firmware variables using STM32CubeIDE. Repeat steps 3-5 for all possible measurement types. 	
Expected Outcome	 Input fields specific to the selected measurement type should be displayed. Device operator should be able to successfully enter values into the displayed input fields without errors. 		
Date Executed	2025-03-30		
Executed by	IB - KO		
Test Case Results	Pass Fail Incomplete		

VER.SW.4 - Individual	VER.SW.4 - Individual Probe Configurability Setting		
Test Overview	This test verifies that the probe configuration bar in the GUI allows configuring individual probe functionalities and selecting which pins are in use.		
Parent Specification	FR-3.1, FR-1.1.X		
Test Procedure	 Start the GUI Choose a me Change the probes are no Set the probes measuremen Monitor correstm32Cubel Check for cofunctionality Repeat steps 	 Connect the device to the operator's pc. Start the GUI by running the Python file. Choose a measurement type. Change the probe configuration based on how many probes are needed. Set the probe's functionalities based on the measurement type. Monitor corresponding firmware variables using STM32CubeIDE. Check for continuity between the selected probe and its functionality circuit. Repeat steps 3-7 for all possible measurement types and probe-functionality combinations. 	
Expected Outcome	 Only the selected probes should be active, while the others remain "Off" as configured in the GUI. Active probes should pass a continuity check for the functionality circuit specified in the probe configuration bar dropdowns. 		
Date Executed	2025-03-30		
Executed by	IB - KO		
Test Case Results	Pass Fail Incomplete		

VER.SW.5 - Measurer	VER.SW.5 - Measurement Control		
Test Overview	This test verifies the functionality of the Start and Stop buttons for measurements.		
Parent Specification	FR-3.3.1, FR-3.3.2		
Test Procedure	 Connect the device to the operator's pc. Start the GUI by running the Python file. Choose a measurement type from the measurement selection menu on the left. Enter relevant values in the input fields. Start measurement using the button. Observe when it stops. Repeat steps 3-6 for all possible measurement types. 		
Expected Outcome	 For static measurements: The Start button should initiate the measurement. For dynamic measurements: The Start button should initiate the measurement, and it should stop automatically when the process completes based on the input values entered. 		
Date Executed	2025-03-30		
Executed by	IB		
Test Case Results	Pass Fail Incomplete		Incomplete

3.2.6.2 Back-End

VER.SW.6 - Device Se	VER.SW.6 - Device Serial Port Connection			
Test Overview	This test is to verify that the code can automatically detect the communication port used when the device is connected to the operator's PC.			
Parent Specification	FR-3.8			
Test Procedure	2. Start the GUI to3. Observe the content	 Connect the device to the operator's pc. Start the GUI by running the Python file. Observe the connection LED on the hardware. Repeat steps 1-4 for different computers and USB ports. 		
Expected Outcome	 Code should automatically detect the COM port used to connect the device. Microcontroller should light up the connection LED on the hardware, indicating a successful connection. 			
Date Executed	2025-03-30			
Executed by	IB - KO			
Test Case Results	Pass Fail Incomplete			

VER.SW.7 - Data Logo	VER.SW.7 - Data Logging		
Test Overview	This test ensures that the results of the measurements are saved correctly in a CSV or JSON file.		
Parent Specification	FR-3.5		
Test Procedure	 Connect the device to the operator's pc. Start the GUI by running the Python file. Choose a measurement type from the measurement selection menu on the left. Enter relevant values in the input fields. Choose the data logging format (.CSV or .JSON). Start measurement using the button. Observe the data file saved in the device operator's PC after the measurement output is displayed. Repeat steps 3-7 for all possible measurement types and data logging combinations. 		

Expected Outcome	 There should be a data file saved on the Desktop. File name should be a timestamp in the YYYYMMDD_HHMMSS format to ensure uniqueness. File should contain all the measured values. 		
Date Executed	2025-03-30		
Executed by	IB - KO		
Test Case Results	Pass Fail Incomplete		Incomplete

VER.SW.8 - Measurement Output Display				
Test Overview	This test verifies that each measurement type displays accurate and relevant outputs corresponding to the selected measurement, ensuring alignment with the expected results.			
Parent Specification	FR-3.4			
Test Procedure	2. Star 3. Choosele 4. Ente 5. Star 6. Obso	 Connect the device to the operator's pc. Start the GUI by running the Python file. Choose a measurement type from the measurement selection menu on the left. Enter relevant values in the input fields. Start measurement using the button. Observe the output displayed once the measurement is completed. Repeat steps 3-6 for all possible measurement types. 		
Expected Outcome	 For static measurements, the output should display a single value, which is the expected result of the measurement. For dynamic measurements, the output should be a graph that is plotted upon the completion of the measurement. 			
Date Executed	2025-03-30			
Executed by	IB			
Test Case Results	Pass Fail Incomplete			Incomplete

3.2.7 Device-to-Host Communication

VER.CM.1 - Device-to	VER.CM.1 - Device-to-Host USB communication sanity check			
Test Overview	This test verifies that the device-to-host USB link is established and the message structure works.			
Parent Specification	FR-2.4			
Test Procedure	 Connect the device to the operator's pc. Start the debug communication interface by running the dedicated Python file. Send messages with random addresses and data combinations. Monitor corresponding firmware registers using STM32CubeIDE. Request the same addresses randomly and monitor the data the MCU returns. 			
Expected Outcome	 The data sent and returned should match for each individual register address. 			
Date Executed	2025-03-30			
Executed by	КО			
Test Case Results	Pass Fail Incomplete			

VER.CM.2 - Probe Co	nfiguration Messages	
Test Overview	This test verifies that the device-to-host USB link can communicate probe configuration messages correctly.	
Parent Specification	FR-2.4, FR-3.1	
Test Procedure	 Connect the device to the operator's pc. Start the debug communication interface by running the dedicated Python file. Send messages with probe configuration register addresses and data combinations. Monitor corresponding firmware registers using STM32CubeIDE. Request the same addresses and monitor the data MCU returns. 	

Expected Outcome	The data sent and returned should match for each individual register address.		
Date Executed	2025-03-30		
Executed by	КО		
Test Case Results	Pass Fail Incomplete		

VER.CM.3 - Measurer	VER.CM.3 - Measurement Configuration Messages			
Test Overview	This test verifies that the device-to-host USB link can communicate measurement configuration messages correctly.			
Parent Specification	FR-2.4, FR-3.2			
Test Procedure	 Connect the device to the operator's pc. Start the debug communication interface by running the dedicated Python file. Send messages with measurement configuration register addresses and data combinations. Monitor corresponding firmware registers using STM32CubeIDE. Request the same addresses and monitor the data MCU returns. 			
Expected Outcome	 The data sent and returned should match for each individual register address. 			
Date Executed	2025-03-30			
Executed by	КО			
Test Case Results	Pass Fail Incomplete			

VER.CM.4 - Measurement Sample Flushing Messages			
Test Overview	This test verifies that the device-to-host USB link can communicate sample data at the end of a measurement.		
Parent Specification	FR-2.4, FR-3.4		
Test Procedure	 Connect the device to the operator's pc. Start the debug communication interface by running the dedicated Python file. Fill the MCU flash with dummy sample data. Send messages with measurement sample request register addresses and data combinations. Monitor corresponding firmware registers using STM32CubeIDE. Monitor the flushed sample data on the host. 		
Expected Outcome	The flushed sample data should match the dummy data.		
Date Executed	2025-03-30		
Executed by	КО		
Test Case Results	Pass Fail Incomplete		

3.2.8 Mechanical Chassis

VER.MC.1 - Structural Integrity / Force Application Test (Without PCB)				
Test Overview	This test verifies that the chassis is robust and can withstand handling without deformation.			
Parent Specification	FR-4.1			
Test Procedure	 Apply a grip (top, botton Visually ins failures. 	 Hold the chassis with one hand. Apply a grip force to the chassis at different locations (top, bottom, sides, etc). Visually inspect for cracks, deformation, or structural failures. Repeat steps 1-3 for all locations. 		
Expected Outcome	 Chassis should show no cracks, warping, or functional damage. 			
Date Executed	2025-02-08			
Executed by	PY			
Test Case Results	Pass Fail Incomplete			

VER.MC.2 - Structural Integrity / Drop Test (Without PCB)			
Test Overview	This test verifies that the chassis is robust and can withstand handling without deformation.		
Parent Specification	FR-4.1		
Test Procedure	 Hold the chassis at 0.5 m height above a hard surface. Drop it in 3 orientations: a. Front facing down b. Side facing down c. Rear facing down Visually inspect for cracks, breakage, or loosening of internal components. 		
Expected Outcome	Chassis should show no cracks, warping, or functional damage.		

Date Executed	2025-02-08		
Executed by	PY		
Test Case Results	Pass	Fail	Incomplete

VER.MC.3 - PCB Secure Mounting Test				
Test Overview	This test verifies that the PCB remains securely in place without movement.			
Parent Specification	FR-4	FR-4		
Test Procedure	 Shake it get left/right, for Listen and for 	 Hold the chassis with one hand. Shake it gently in multiple directions (up/down, left/right, forward/backward). Listen and feel for any movement or rattling inside. Repeat steps 2-3 in a different orientation. 		
Expected Outcome	 There should be no PCB misalignment, movement or rattling after shaking. 			
Date Executed	2025-03-30			
Executed by	PY			
Test Case Results	Pass Fail Incomplete			

VER.MC.4 - Probe Slie	VER.MC.4 - Probe Slider Mechanism Test		
Test Overview	This test verifies that the sliders function smoothly and extend the selected probes.		
Parent Specification	FR-4.1		
Test Procedure	 Move each probe slider up and down manually 10 times to check for smoothness. Observe for any excessive resistance, jamming, or misalignment. Slide all the probes downward. Align the probes with the test samples to ensure alignment with the measuring points. 		

Expected Outcome	Sliders should operate smoothly with no excessive resistance, and probes should extend properly aligned.		
Date Executed	2025-02-08		
Executed by	PY		
Test Case Results	Pass Fail Incomplete		

VER.MC.5 - Visual Indicator Functionality Test				
Test Overview	This test verifies that the LEDs can be viewed from outside the case.			
Parent Specification	FR-4.2	FR-4.2		
Test Procedure	 Connect the hardware to a power supply. Observe from outside the case if the LEDs are clear to see. 			
Expected Outcome	 LED indicators should be clearly seen from outside the chassis. 			
Date Executed	2025-03-30			
Executed by	PY - DS			
Test Case Results	Pass Fail Incomplete			

3.2.9 End-to-End Measurements

VER.EE.1 - DC Resistance Measurement (2-probe)			
Test Overview	This test verifies that the device can complete a 2-probe DC Resistance measurement.		
Parent Specification	FR-1.2		
Test Procedure	 Connect the device to the operator's pc. Connect two probes to a material to test. Start the GUI by running the Python file. Choose the correct measurement type on the left side menu. Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. Repeat steps 5-9 for different probe configurations. 		
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 		
Date Executed	2025-04-01		
Executed by	TEAM		
Test Case Results	Pass Fail Incomplete		

VER.EE.2 - Current-Voltage Measurement (2-probe)			
Test Overview	This test verifies that the device can complete a 2-probe Current-Voltage measurement.		
Parent Specification	FR-1.2		
Test Procedure	 Connect the device to the office of the connect two probes to a magnetic of the office of the connect two probes to a magnetic office of the correct measurement. Set the probe functionalities type and probe amount us bar. Enter the necessary input office of the connect of the conne	naterial to test. e Python file. rement type on the left side es based on the measurement ing the probe configuration values. red. tput values to the expected	
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 		
Date Executed	2025-04-01		
Executed by	TEAM		
Test Case Results	Pass Fail Incomplete		

VER.EE.3 - Capacitance-Voltage Measurement (2-probe)			
Test Overview	This test verifies that the device can complete a 2-probe Capacitance-Voltage measurement.		
Parent Specification	FR-1.2		
Test Procedure	 Connect the device to the operator's pc. Connect two probes to a material to test. Start the GUI by running the Python file. Choose the correct measurement type on the left side menu. Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. Repeat steps 5-9 for different probe configurations. 		
Expected Outcome	The measured values should be almost the same as the expected measurement result within acceptable tolerances.		
Date Executed	2025-04-07		
Executed by	TEAM		
Test Case Results	Pass	Fail	Incomplete

VER.EE.4 - Impedance Spectroscopy Measurement (2-probe)						
Test Overview		This test verifies that the device can complete a 2-probe Impedance Spectroscopy measurement.				
Parent Specification	FR-1.2					
Test Procedure	 Connect the device to the operator's pc. Connect two probes to a material to test. Start the GUI by running the Python file. Choose the correct measurement type on the left side menu. Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. Repeat steps 5-9 for different probe configurations. 					
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 					
Date Executed	2025-04-07					
Executed by	TEAM	TEAM				
Test Case Results	Pass Fail (Partially) Incomplete					
	Impedance spectroscopy aims to calculate impedance and phase of materials under different frequencies. It is found that the impedance portion is passing but the phase is failing . This was root caused by multiple DMA channels not capturing samples in a synced manner even though ADCs sample in sync (verified with an oscilloscope).					

VER.EE.5 - Transfer Characteristics Measurement (3-probe)						
Test Overview		This test verifies that the device can complete a 3-probe Transfer Characteristics measurement.				
Parent Specification	FR-1.3					
Test Procedure	 Connect thr Start the GL Choose the menu. Set the probar. Enter the net Start measuments Observe the Compare th 	 Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. 				
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 					
Date Executed	2025-04-01	2025-04-01				
Executed by	TEAM					
Test Case Results	Pass	Fail	Incomplete			

VER.EE.6 - Output Characteristics Measurement (3-probe)					
Test Overview		This test verifies that the device can complete a 3-probe Output Characteristics measurement.			
Parent Specification	FR-1.3				
Test Procedure	 Connect the 3. Start the GU Choose the menu. Set the prolytype and probar. Enter the new Start measures Observe the property of the prolytype. 	 Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. 			
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 				
Date Executed	2025-04-01				
Executed by	TEAM				
Test Case Results	Pass	Fail	Incomplete		

VER.EE.7- Capacitance-Voltage Measurement (3-probe)						
Test Overview		This test verifies that the device can complete a 3-probe Capacitance-Voltage measurement.				
Parent Specification	FR-1.3					
Test Procedure	 Connect thing. Start the Global Attention. Choose the menu. Set the prolotype and probar. Enter the new than a contract than a contra	 Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. 				
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 					
Date Executed	2025-04-08					
Executed by	TEAM					
Test Case Results	Pass	Fail	Incomplete			

VER.EE.8 - Electrochemical Measurement (3-probe)					
Test Overview		This test verifies that the device can complete a 3-probe Electrochemical measurement.			
Parent Specification	FR-1.3				
Test Procedure	 Connect the device to the operator's pc. Connect three probes to a material to test. Start the GUI by running the Python file. Choose the correct measurement type on the left side menu. Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. Repeat the steps 5-9 for different probe configurations. 				
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 				
Date Executed					
Executed by					
Test Case Results	Pass Fail Incomplete				
	Due to lack of samples or discrete components that fit into the category of "electrochemical", this measurement was not tested. The code flow is the same as impedance spectroscopy which is verified in other end-to-end system tests. The risk taken by not testing this measurement is justifiable as the code/hardware portion is verified in general and only lacking test is actually seeing performance with electrochemical materials.				

VER.EE.9 - Probe Resistance Measurement (4-probe)					
Test Overview		This test verifies that the device can complete a 4-probe Probe Resistance measurement.			
Parent Specification	FR-1.4				
Test Procedure	 Connect for 3. Start the Gl Choose the menu. Set the probar. Enter the new control of the control of the	Set the probe functionalities based on the measurement type and probe amount using the probe configuration			
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 				
Date Executed	2025-04-08				
Executed by	TEAM				
Test Case Results	Pass	Fail	Incomplete		

VER.EE.10 - Low Resistance Measurement (4-probe)						
Test Overview		This test verifies that the device can complete a 4-probe Low Resistance measurement.				
Parent Specification	FR-1.4					
Test Procedure	 Connect for an array of the connect for an array of the connect the connect for an array of the connect for a conne	 Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. 				
Expected Outcome	 The measured values should be almost the same as the expected measurement result within acceptable tolerances. 					
Date Executed	2025-04-08					
Executed by	TEAM	TEAM				
Test Case Results	Pass	Fail	Incomplete			

VER.EE.11 - Impedance Spectroscopy Measurement (4-probe)						
Test Overview		This test verifies that the device can complete a 4-probe Impedance Spectroscopy measurement.				
Parent Specification	FR-1.4					
Test Procedure	 Connect the device to the operator's pc. Connect four probes to a material to test. Start the GUI by running the Python file. Choose the correct measurement type on the left side menu. Set the probe functionalities based on the measurement type and probe amount using the probe configuration bar. Enter the necessary input values. Start measurement. Observe the output displayed. Compare the measured output values to the expected output values. Repeat steps 5-9 for different probe configurations. 					
Expected Outcome	The measured values should be almost the same as the expected measurement result within acceptable tolerances.					
Test Case Results	Pass Fail (Partially) Incomplete					
	Impedance spectroscopy aims to calculate impedance and phase of materials under different frequencies. It is found that the impedance portion is passing but the phase is failing. This was root caused by multiple DMA channels not capturing samples in a synced manner even though ADCs sample in sync (verified with an oscilloscope).					

4. Product Validation

Validation tests determine whether the system as a whole meets the user needs and intended application in its real-world context. These tests confirm that the final system fulfills its purpose effectively, typically involving performance evaluation, user testing, and comparisons against expected outcomes.

4.1 Validation Plan Description

This section explains the OrcaProbe validation test plans. Each validation criterion is outlined below in Section 4.2 using the same test cards as in Section 3.2. Please refer to Section 3.1 for the explanation of the test cards.

For the validation criteria, there are certain conceptual changes in the test card. Certain parts are taken out, such as *Parent Specification*, *Execution Date*, *Executed By* and *Test Case Results*, as they do not apply to validation tests. Validation criteria are directly or indirectly correlated to the whole set of product specifications. *Test Results* are shown in Table 1 after the validation test cards.

For validation tests, actual printed thin film characterization scenarios are mimicked.

Table 1 lists all the scenarios that are under the scope of the validation tests. Validation criteria are evaluated on a scenario basis.

4.2 Validation Criteria

VAL.1 - Measurement Accuracy				
Criterion Overview	This criterion validates that OrcaProbe can provide accurate and precise data that is usable from the operator's point of view.			
Procedure	 Using conventional methods, measure the desired values of a material and perform the necessary measurements. Carry out the same measurement(s) using OrcaProbe. Compare the values and note the difference. 			
Expected Outcome	OrcaProbe should produce a value within ±5% of the expected result of the measurement.			

VAL.2 - Reconfigurability				
Criterion Overview	This criterion validates that OrcaProbe can provide reconfigurability of the probes and measurement types.			
Procedure	 Using conventional methods, measure the desired values. In the process, record the number of times a new tool is used, some setup is changed and/or material is repositioned. Carry out the measurement using OrcaProbe and record the number of times a new tool is used, some setup is changed and/or material is repositioned. Compare the number of times OrcaProbe was reused to carry out different measurements. 			
Expected Outcome	OrcaProbe should require significantly less number of configuring actions and/or need help from other tools.			

VAL.3 - Process Speedup				
Criterion Overview	This criterion validates the process speed-up users achieve by using OrcaProbe compared to conventional methods.			
Procedure	 Using conventional methods, measure the desired values for a material and the measurement(s) that will be executed. Record the time it takes to complete the steps. Carry out the measurement using OrcaProbe and record the time in the same manner. Compare the difference in time spent and the time saved with OrcaProbe. 			
Expected Outcome	OrcaProbe should speed up the process by at least 5 times.			

Table 1: OrcaProbe Validation Test Results

(Pass / Fail / Incomplete [Incp.]) - (Prl)*: Partially

Test Scenario	rio Measurement Accuracy			Reconfigurability			Process Speedup		
	PDMS PEDOT:PSS - Capacitors								
Sheet Resistance w/2-4 probe resistance	Pass	Fail	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.
Capacitance character. w/2 probe	Pass	Fail	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.
Impedance Spectros. w/2-4 probe	Pass	1-Fail (Prl)*	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.
	Ca	arbon N	anotube	e (MWC	NT) - Re	esistors			
Sheet Resistance w/2-4 probe resistance	Pass	Fail	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.
Capacitance character. w/2 probe	Pass	Fail	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.
Impedance Spectros. w/2-4 probe	Pass	1-Fail (Prl)*	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.
	Ca	rbon Na	notube	(SWCN	T) - Tra	nsistors	;		•
Gate Capacitance Character. w/ 3 probe	Pass	2-Fail	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.
Drain source resistance w/ 2 probe	Pass	Fail	Incp.	Pass	3-Fail	Incp.	Pass	Fail	Incp.
Transistor character. w/ output and transfer	Pass	Fail	Incp.	Pass	Fail	Incp.	Pass	Fail	Incp.

The failed cases in the validation are explained below according to their number labels:

- **1 -** Impedance spectroscopy with 2 and 4-probes for PEDOT:PSS capacitors and Carbon Nanotube resistors partially failed accuracy category due to phase reconstruction not working as desired. The impedance amplitudes were still in the expected range, however, phase differences were off by more than 5%.
- **2 -** 3- probe gate capacitance measurement accuracy in some cases is over 5%. This is due to the difficulty in measuring signals for the small gate capacitances of typical transistors. The test still functions properly, but the accuracy of measurement is lower due to hardware limitations.
- **3 -** Drain source resistance measurement with 2-probes for Carbon Nanotube transistors have failed in the Reconfigurability category due to the dependence on an external power supply to bias the gate electrode. This was mainly due to no 3-probe measurement method covering this case and the only suitable method being a 2-probe one. It can still offer speedup and accurate readings, however does not provide the desired reconfigurability.

Appendix A. Team Roles

Name	Initials	Tech Lead	Management Lead	
Aaron Loh	AL	Monitoring System	Team Liaison	
Dipak Shrestha	DS	Switching Network	Inventory Manager	
Idil Bil	IB	Software / GUI	Project Manager	
Kerem Oktay	КО	Firmware / MCU	Document Manager	
Peggy Yuan	PY	Driving System & Mechanical Design	Treasurer	

Appendix B. Contributions

Section	Major Contribution	Minor Contribution	Author	Reviewer
1. Project Overview	AL	PY	AL	PY
2. Document Overview	DS	КО	DS	КО
3.1 Verification Plan Description	ко	IB	КО	IB
3.2 Test Plans	KO IB	AL DS PY	AL DS IB KO PY	AL DS IB KO PY
4.1 Validation Plan Description	КО	IB	КО	IB
4.2 Validation Criteria	KO IB	-	KO IB	DS